

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT5092580

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
RULON J. LARSEN III	08/09/2018
ADAM L. COHEN	08/02/2018
RECEIVING PARTY DATA	
Name:	MICROFABRICA INC.
Street Address:	7911 HASKELL AVENUE
City:	VAN NUYS
State/Country:	CALIFORNIA
Postal Code:	91406
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15206782
CORRESPONDENCE DATA	
Fax Number:	(818)997-3659
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	8187863322 X105
Email:	dsmalley@microfabrica.com
Correspondent Name:	DENNIS R. SMALLEY
Address Line 1:	7911 HASKELL AVENUE
Address Line 4:	VAN NUYS, CALIFORNIA 91406
ATTORNEY DOCKET NUMBER:	P-US347-A-MF
NAME OF SUBMITTER:	DENNIS R. SMALLEY
SIGNATURE:	/Dennis R. Smalley/
DATE SIGNED:	08/10/2018
Total Attachments: 2	
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ASSIGNMENT – MULTIPLE INVENTORS – ALL INVENTIONS COMMONLY OWNED

For good and valuable consideration, receipt of which is hereby acknowledged, we

Name	Mailing Address	Residence City and State
Rulon J. Larsen III	7911 Haskell Avenue, Van Nuys, CA 91406	Colorado Springs, Colorado
Adam L. Cohen	7911 Haskell Avenue, Van Nuys, CA 91406	Dallas, Texas

hereby sell, assign and transfer to Microfabrica Inc. having a place of business at 7911 Haskell Avenue, Van Nuys, California 91406, its successors, and assigns, the entire right, title, and interest throughout the world to the inventions that we have invented or co-invented, though possibly not claimed, as set forth in the following patent(s) and/or patent application(s)

Country	Patent or App. No.	Issue Date or Filing Date	Title
US	App. No. 15/206,782	Filed: July 11, 2016	Plasma Etching of Dielectric Sacrificial Material from Reentrant Multi-Layer Metal Structures

and for all other patent applications and patents of every country for said inventions (whether or not yet filed), including divisions, reissues, continuations, and extensions thereof, and all rights of priority resulting from the filing of said applications; we authorize the above-named assignee to apply for other patents in the United States and/or foreign countries for said inventions, and to claim all rights of priority without further authorization from me; we agree to execute all papers useful in connection with these patent applications and/or patents, and generally to do everything possible to aid said assignee, their successors, assigns, and nominees, at their request and expense, in obtaining and enforcing patents for said inventions in all countries; and we request that the United States Patent and Trademark Office and all other patent granting authorities to issue all patents granted for said inventions to the above-named assignee, its successors, and assigns.

First Inventor

Executed this 9th day of August, 2018

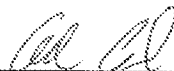

(Signature)

Rulon J. Larsen III

Name (Typed or Printed)

Second Inventor

Executed this 2ND day of August, 2018



(Signature)

Adam L. Cohen

Name (Typed or Printed)